

N-Channel Enhancement MOSFET

Features

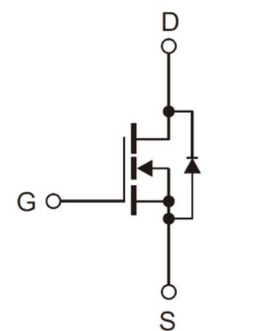
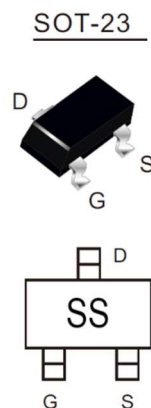
- TrenchFET Power MOSFET
- Voltage Controlled Small Signal Switch
- Halogen-Free & Lead-Free

Product Summary		
V_{DS}	$R_{DS(on)} (\Omega)_{Max}$	$I_D (A)$
50V	2.5 @ 10V	0.34
	3 @ 4.5V	

Application

- Load Switch for Portable Devices
- Solid-state relays
- DC/DC Converter

Marking information



N-channel MOSFET

Absolute Maximum Ratings (at $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous drain current ($T_A=25^\circ\text{C}$)	I_D	0.34	A
Continuous drain current ($T_A=70^\circ\text{C}$)	I_D	0.272	A
Power Dissipation	P_D	0.35	W
Operating Junction	T_J	-55~150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55~150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ²⁾	$R_{\theta JA}$	357	$^\circ\text{C/W}$

Characteristics at T_J = 25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at V _{GS} =0V, I _D =250μA	BV _{DSS}	50			V
Drain-Source Leakage Current at V _{DS} =50V, V _{GS} =0V	I _{DSS}			1	μA
Gate Leakage Current at V _{GS} =±20V, V _{DS} =0V	I _{GSS}			±0.1	μA
Gate-Source Threshold Voltage at V _{DS} =V _{GS} , I _D =1mA	V _{GS(th)}	0.8		1.6	V
Drain-Source On-State Resistance at V _{GS} =10V, I _D =300mA at V _{GS} =4.5V, I _D =200mA	R _{DS(on)}		1.1 1.2	2.5 3	Ω
DYNAMIC PARAMETERS					
Input Capacitance at V _{DS} =25V, V _{GS} =0V, f=1MHz	C _{iss}		17.5		pF
Output Capacitance at V _{DS} =25V, V _{GS} =0V, f=1MHz	C _{oss}		11.5		pF
Reverse Transfer Capacitance at V _{DS} =25V, V _{GS} =0V, f=1MHz	C _{rss}		6.5		pF
Gate charge total at V _{DS} =25V, I _D =0.3A, V _{GS} =10V	Q _g		1.7	2.4	nC
Turn-On Delay Time at V _{DD} =25V, I _D =0.3A, R _{GEN} =6Ω, V _{GS} =10V	t _{d(on)}		5		nS
Turn-Off Delay Time at V _{DD} =25V, I _D =0.3A, R _{GEN} =6Ω, V _{GS} =10V	t _{d(off)}		17		nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at I _S =0.3A, V _{GS} =0V	V _{SD}			1.2	V
Maximum Body-Diode Continuous Current	I _S			340	mA
Body Diode Reverse Recovery Time at V _R =25V, V _{GS} =0V I _S =0.3A, di/dt=100A/μs	trr		30		nS

Electrical Characteristics Curves

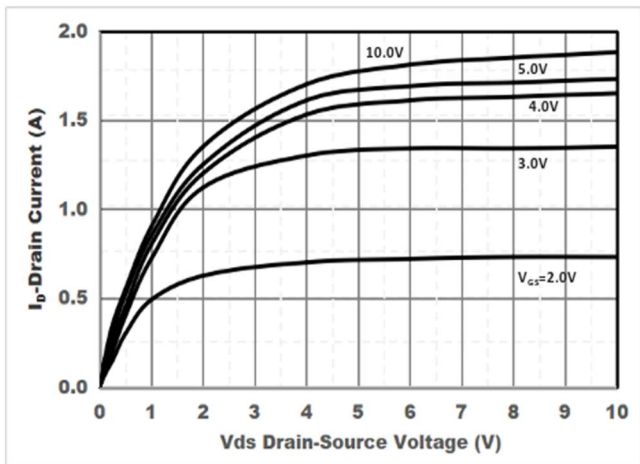


Figure1. Output Characteristics

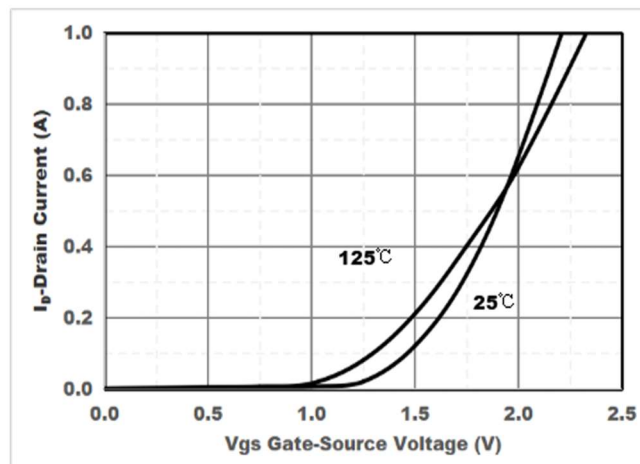


Figure2. Transfer Characteristics

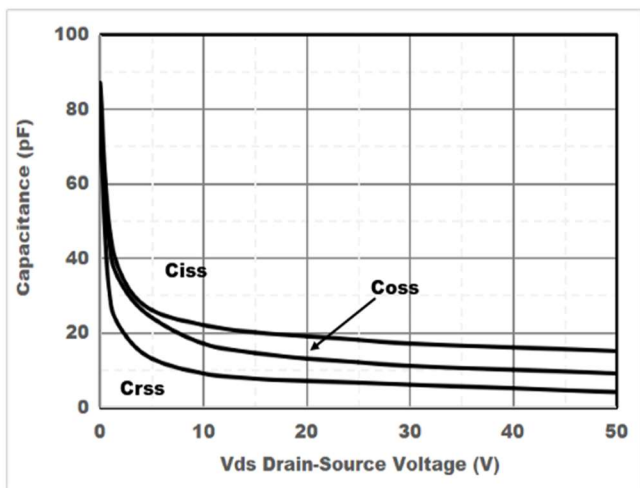


Figure3. Capacitance Characteristics

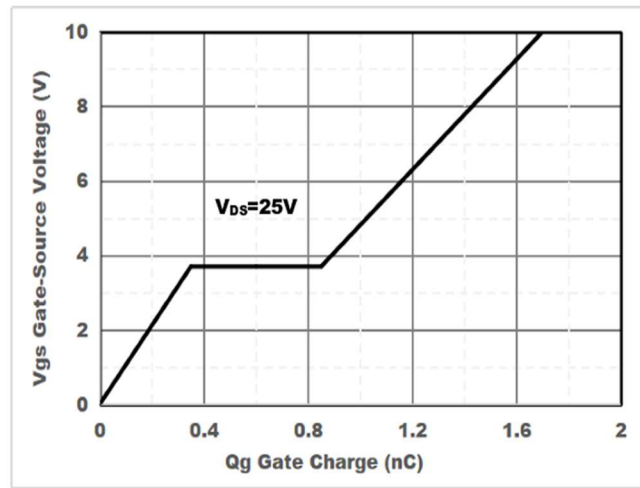


Figure4. Gate Charge

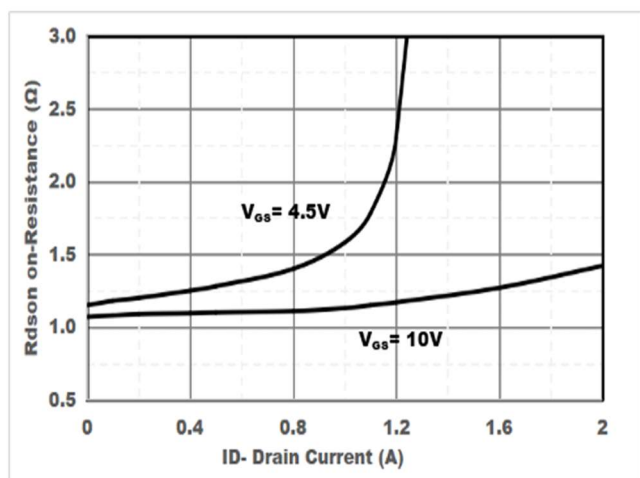


Figure5. Drain-Source on Resistance

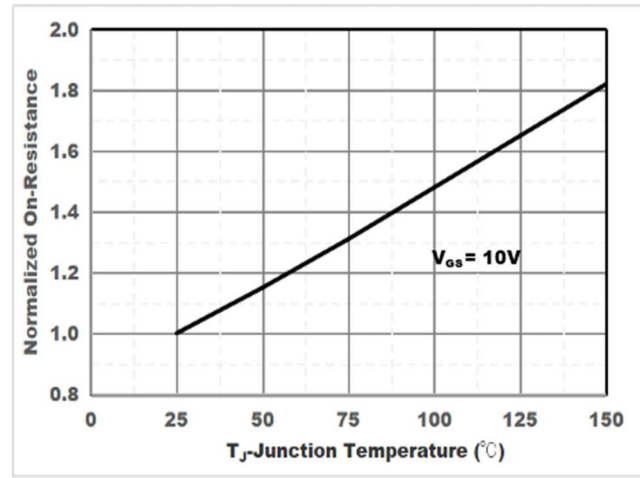


Figure6. Drain-Source on Resistance

Electrical Characteristics Curves

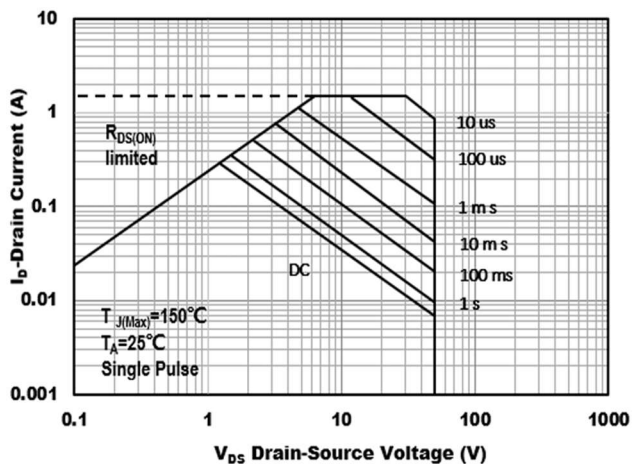


Figure7. Safe Operation Area

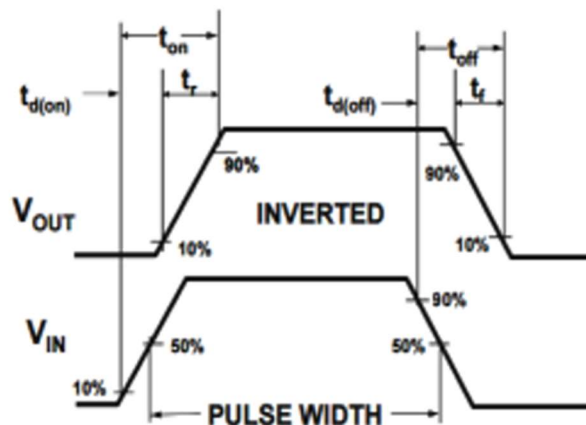
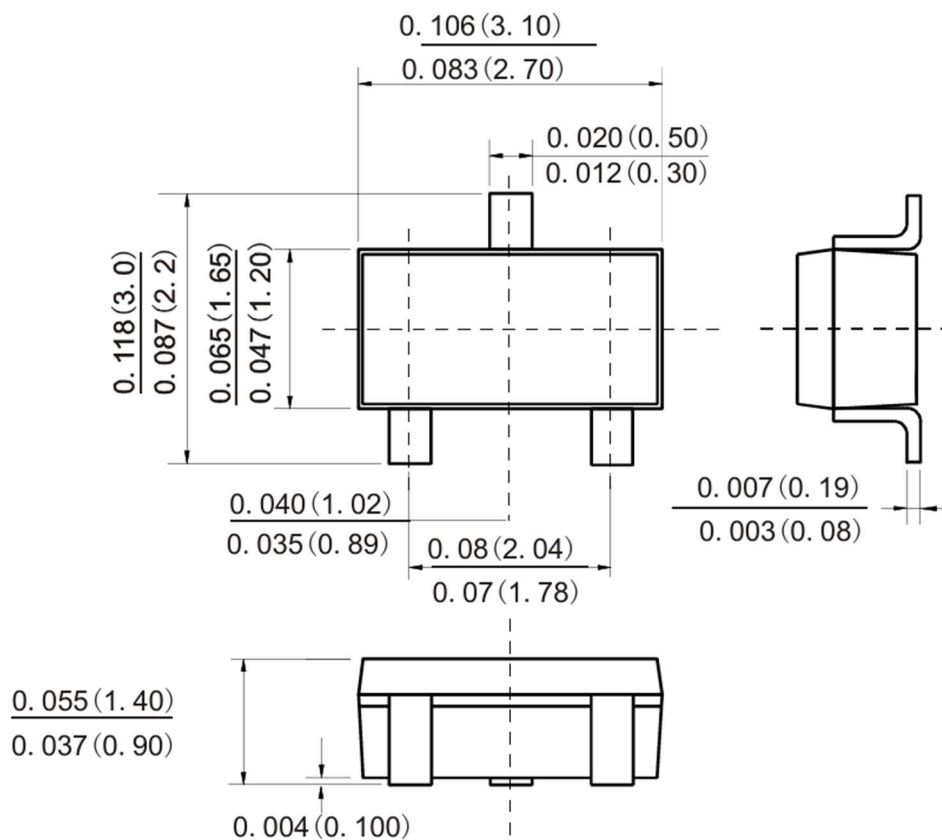


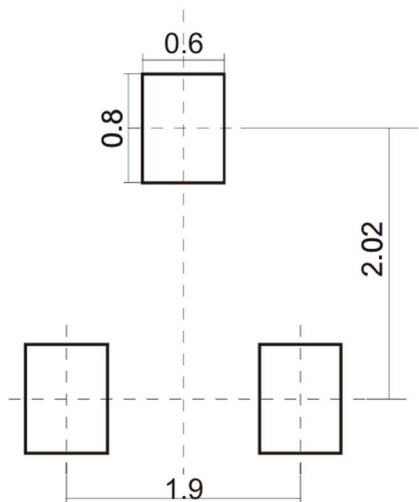
Figure8. Switching wave

Package Outline Dimensions (Units: mm) SOT-23



Dimensions in inches and (millimeters)

Suggested Pad Layout



Dimensions in millimeters

Order Information

Part Number	Package	Quantity
ShBSS138	SOT-23	3000